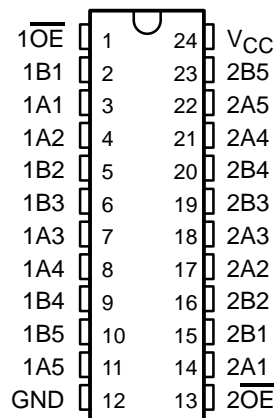


SN54CBTD3384, SN74CBTD3384 10-BIT BUS SWITCHES WITH LEVEL SHIFTING

SCDS025F – MAY 1995 – REVISED OCTOBER 1996

- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input and Output Levels
- Designed to Be Used in Level-Shifting Applications
- Package Options Include Plastic Shrink Small-Outline (DB), Small-Outline (DW), Thin Shrink Small-Outline (PW), Ceramic DIP (JT), and Ceramic Flat (W) Packages

SN54CBTD3384 . . . JT OR W PACKAGE
SN74CBTD3384 . . . DB, DW, OR PW PACKAGE
(TOP VIEW)



description

The 'CBTD3384 provide ten bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switches allows connections to be made without adding propagation delay. A diode to V_{CC} is integrated on the die to allow for level shifting between 5-V inputs and 3.3-V outputs.

These devices are organized as two 5-bit switches with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the switch is on and port A is connected to port B. When \overline{OE} is high, the switch is open and a high-impedance state exists between the two ports.

The SN74CBTD3384 is available in TI's shrink small-outline (DB) and thin shrink small-outline (PW) packages, which provide the same I/O pin count and functionality of standard small-outline packages in less than half the printed circuit board area.

The SN54CBTD3384 is characterized for operation over the full military temperature range from -55°C to 125°C . The SN74CBTD3384 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE

$\overline{1OE}$	$\overline{2OE}$	1B1 – 1B5	2B1 – 2B5
L	L	1A1–1A5	2A1–2A5
L	H	1A1–1A5	Z
H	L	Z	2A1–2A5
H	H	Z	Z



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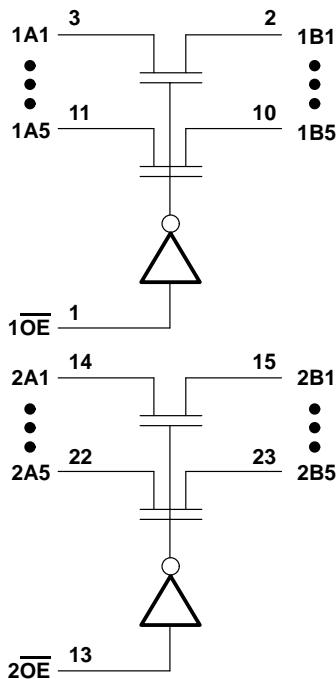
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**TEXAS
INSTRUMENTS**

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logic diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7 V
Continuous channel current	128 mA
Input clamp current, I_{IK} ($V_{I/O} < 0$)	–50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2):	
DB package	0.65 W
DW package	1.7 W
PW package	0.7 W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.
For more information, refer to the *Package Thermal Considerations* application note in the *ABT Advanced BiCMOS Technology Data Book*.

recommended operating conditions

		SN54CBTD3384		SN74CBTD3384		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	4.5	5.5	4.5	5.5	V
V_{IH}	High-level control input voltage	2		2		V
V_{IL}	Low-level control input voltage		0.8		0.8	V
T_A	Operating free-air temperature	–55	125	–40	85	°C

SN54CBTD3384, SN74CBTD3384
10-BIT BUS SWITCHES
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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SN54CBTD3384			SN74CBTD3384			UNIT
		MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}	$V_{CC} = 4.5\text{ V}$, $I_I = -18\text{ mA}$			-1.2			-1.2	V
V_{OH}	See Figure 1							
I_I	$V_{CC} = 5.5\text{ V}$, $V_I = 5.5\text{ V}$ or GND			± 1			± 1	μA
I_{CC}	$V_{CC} = 5.5\text{ V}$, $V_I = V_{CC}$ or GND, $I_O = 0$			1.5			1.5	mA
ΔI_{CC}^\ddagger	Control pins $V_{CC} = 5.5\text{ V}$, One input at 3.4 V, Other inputs at V_{CC} or GND			2.5			2.5	mA
C_i	Control pins $V_I = 3\text{ V}$ or 0			3			3	pF
$C_{io}(\text{OFF})$	$V_O = 3\text{ V}$ or 0, $\overline{OE} = V_{CC}$			3.5			3.5	pF
r_{on}^\S	$V_{CC} = 4.5\text{ V}$	$V_I = 0$, $I_I = 64\text{ mA}$		5			5	Ω
		$V_I = 0$, $I_I = 30\text{ mA}$		5			5	
		$V_I = 2.4\text{ V}$, $I_I = 15\text{ mA}$		35			35	

† Typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

§ Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature range, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54CBTD3384		SN74CBTD3384		UNIT
			MIN	MAX	MIN	MAX	
t_{pd}^\P	A or B	B or A		0.25		0.25	ns
t_{en}	\overline{OE}	A or B	2.2	7.2	2.3	7	ns
t_{dis}	\overline{OE}	A or B	1.6	5.5	1.7	5.3	ns

¶ This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

SN54CBTD3384, SN74CBTD3384

10-BIT BUS SWITCHES

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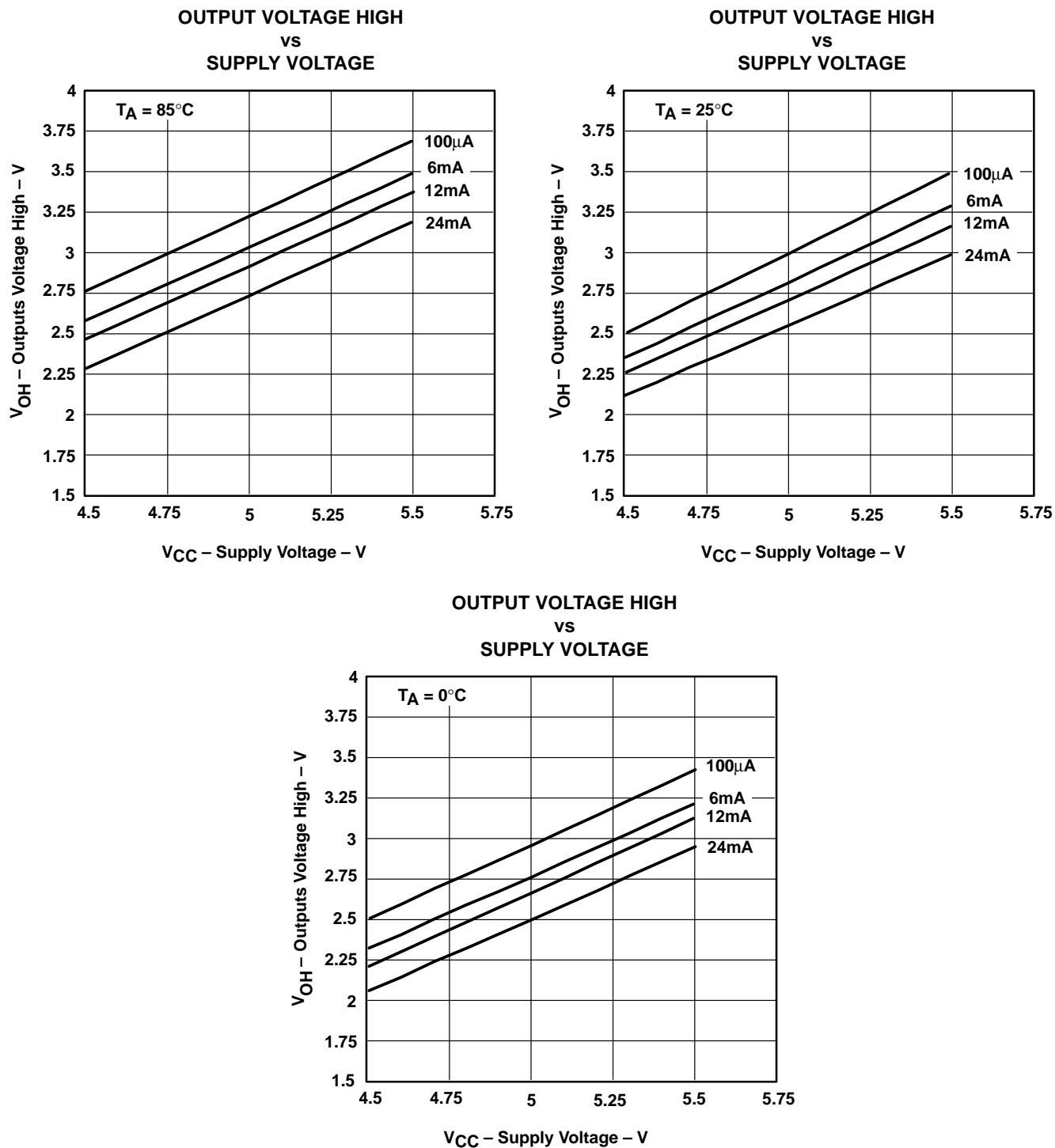
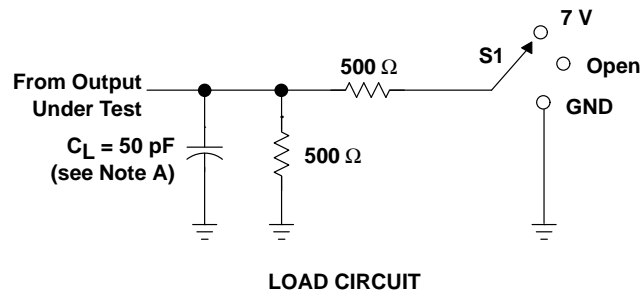
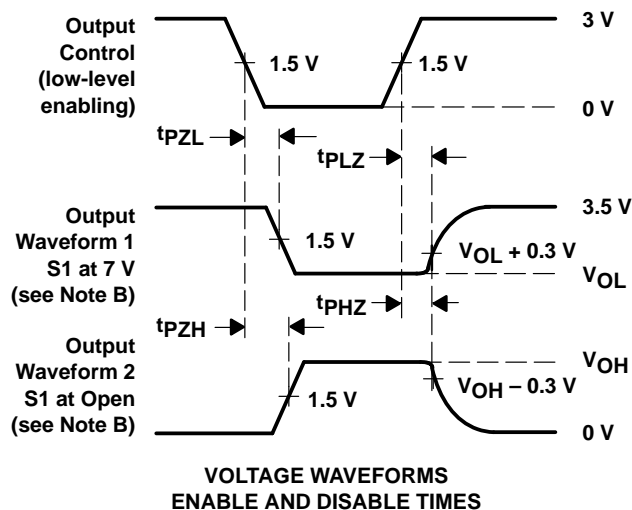
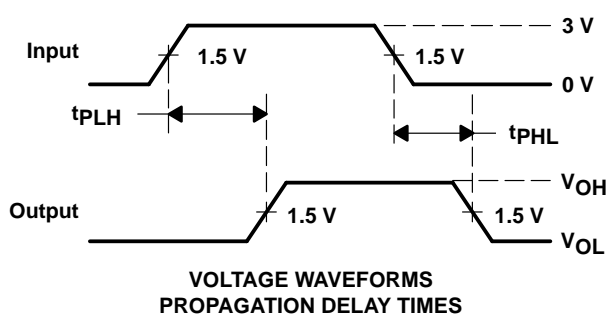


Figure 1. V_{OH} Values

PARAMETER MEASUREMENT INFORMATION



TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 2. Load Circuit and Voltage Waveforms

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